FDS9400A

FAIRCHILE

30V P-Channel PowerTrench[®] MOSFET

General Description

This P-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 25V).

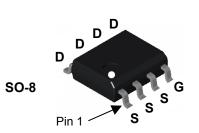
Applications

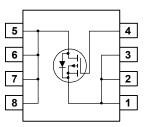
- Power management
- Load switch
- Battery protection

Features

- -3.4 A, -30 V $R_{DS(ON)} = 130 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 200 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Low gate charge (2.4nC typical)
- Fast switching speed
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability

12mm





Absolute Maximum Ratings T_A=25°C unless otherwise noted

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Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			-30		
V _{GSS}	Gate-Source Voltage			±25		
ID	Drain Current – Continuous (Note 1a)		(Note 1a)	-3.4	4 A	
		– Pulsed		-10		
P _D	Power Dissipation for Single Operation		n (Note 1a)	2.5	W	
			(Note 1b)	1.2		
			(Note 1c)	1		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			–55 to +175 °		
	I Characte					
R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		ient (Note 1a)	50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1c)			125 °		
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)			25		
Packag	e Marking	and Ordering I	nformation			
	Marking	Device	Reel Size	Tape width	Quantity	

13"

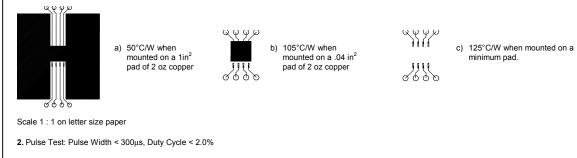
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2500 units

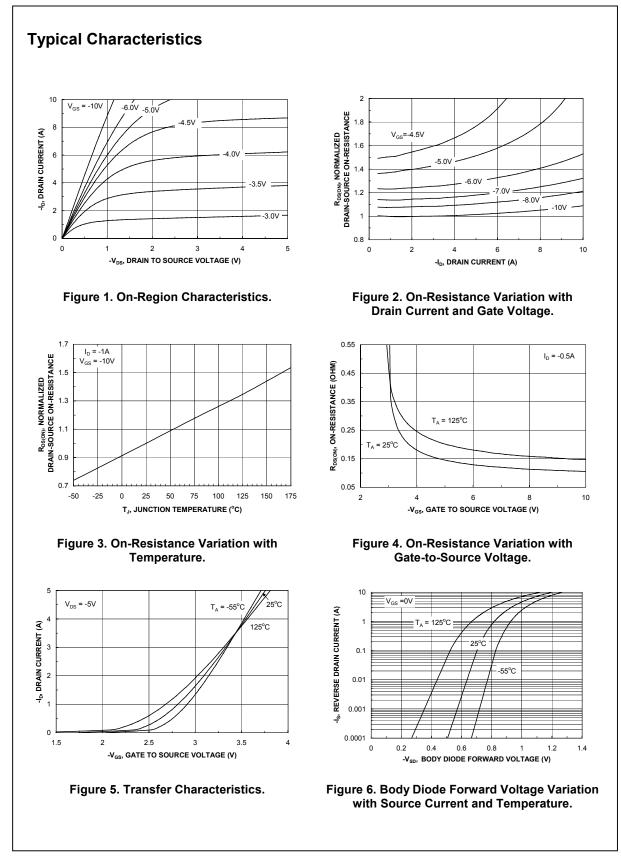
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS} Drain–Source Breakdown Voltage		$V_{GS} = 0 V, I_{D} = -250 \mu A$	-30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 25 V$, $V_{DS} = 0 V$			100	NA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -25 V$, $V_{DS} = 0 V$			-100	NA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = –250 µA, Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -10 \ V, & I_D = -1.0 \ A \\ V_{GS} = -4.5 \ V, & I_D = -0.5 \ A \\ V_{GS} = -10 \ V, \ I_D = -1.0 \ A, \ T_J = 125^\circ C \end{array} $		105 157 147	130 200 210	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-5			А
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -3.4 A$		4.5		S
Dynamic	Characteristics	•		1	1	
C _{iss}	Input Capacitance	$V_{DS} = -15 V$, $V_{GS} = 0 V$,		205		pF
Coss	Output Capacitance	f = 1.0 MHz		55		pF
Crss	Reverse Transfer Capacitance			26		pF
Switchir	g Characteristics (Note 2)	•				
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -15 V$, $I_D = -1 A$,		4.5	9	ns
t _r	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		12.5	23	ns
t _{d(off)}	Turn–Off Delay Time			11	20	ns
t _f	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	$V_{DS} = -15 V$, $I_D = -1 A$,		2.4	3.5	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -5 V$		1.0		nC
Q _{gd}	Gate–Drain Charge			0.7		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
l _s	Maximum Continuous Drain–Sourc				-2.1	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)	1	-0.8	-1.2	V



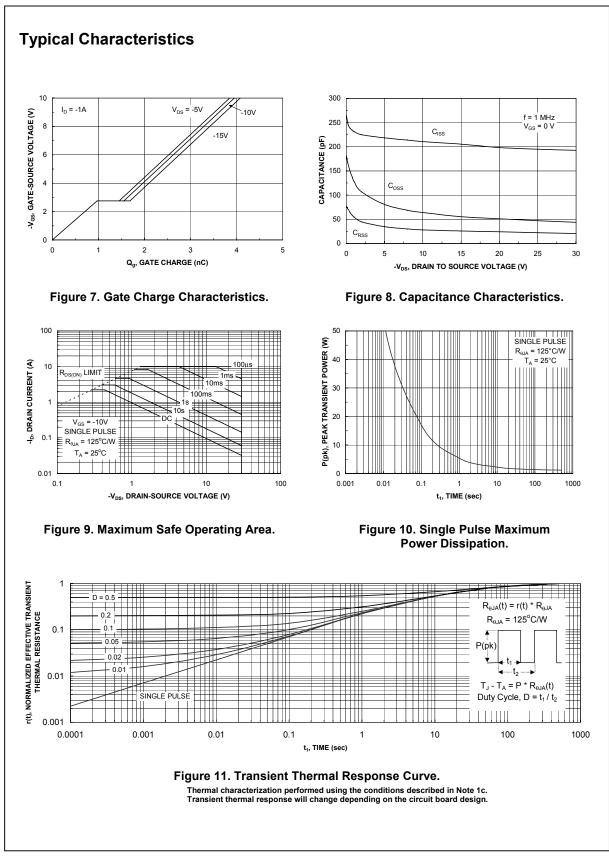


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